



100V/2.6A N-Channel Advanced Power MOSFET

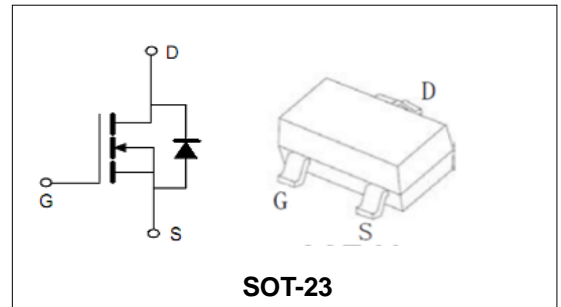
Features

- High density cell design for ultra low Rdson

Applications

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

BVDSS	100	V
ID	2.6	A
RDSON@VGS=4.5V	135	mΩ
RDSON@VGS=10V	115	mΩ



Order Information

Product	Package	Marking	Reel Size	Reel	Carton
PTL03N10	SOT-23	3N10	7inch	3000PCS	180000PCS

Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit	
Common Ratings (TC=25°C Unless Otherwise Noted)				
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	100	V	
V_{GS}	Gate-Source Voltage	±20	V	
T_J	Maximum Junction Temperature	150	°C	
T_{STG}	Storage Temperature Range	-55 to 150	°C	
I_S	Diode Continuous Forward Current	TC =25°C	2.6	A
Mounted on Large Heat Sink				
I_{DM}	Pulse Drain Current Tested (Silicon Limit) (Note1)	TC =25°C	10	A
I_D	Continuous Drain current	TC =25°C	2.6	A
P_D	Maximum Power Dissipation	TC =25°C	1	W
$R_{θJA}$	Thermal Resistance Junction-to-Ambient (Note2)		125	°C/W



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Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
Static Electrical Characteristics @ T_J = 25°C (unless otherwise stated)						
V _{(BR)DSS}	Drain- Source Breakdown Voltage	VGS=0V ID=250μA	100	--	--	V
I _{DSS}	Zero Gate Voltage Drain current	VDS=100V,VGS=0V	--	--	1	μA
I _{GSS}	Gate-Body Leakage Current	VGS=±20V,VDS=0V	--	--	±100	nA
V _{GS(TH)}	Gate Threshold Voltage	VDS=VGS,ID=250μA	1	1.8	3	V
R _{DS(ON)}	Drain-Source On-State Resistance (Note3)	VGS=10V, ID=2.5A	--	115	165	mΩ
		VGS=4.5V, ID=1.5A	--	135	180	mΩ
Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise stated) (Note4)						
C _{iss}	Input Capacitance	VDS=30V, VGS=0V, F=1MHz	--	405	--	pF
C _{oss}	Output Capacitance		--	36	--	pF
C _{rss}	Reverse Transfer Capacitance		--	18	--	pF
Q _g	Total Gate Charge	VGS=10V, VDS=30V, ID=1 A	--	9	--	nC
Q _{gs}	Gate-Source Charge		--	1.5	--	nC
Q _{gd}	Gate-Drain Charge		--	2.1	--	nC
Switching Characteristics (Note4)						
t _{d(on)}	Turn-on Delay Time	VDS=30V, ID=1A, RG=6.8Ω, VGS=10V	--	9	--	nS
t _r	Turn-on Rise Time		--	8.1	--	nS
t _{d(off)}	Turn-off Delay Time		--	20	--	nS
t _f	Turn-off Fall Time		--	13.5	--	nS
Source- Drain Diode Characteristics @ T_J = 25°C (unless otherwise stated)						
V _{SD}	Forward on voltage	IS=2.5A,VGS=0V	--	--	1.3	V

Note:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t ≤ 10 sec.
3. Pulse Test: pulse width ≤ 300 us, duty cycle ≤ 2%.
4. Guranteed by design, not subject to production testing.



Typical Characteristics

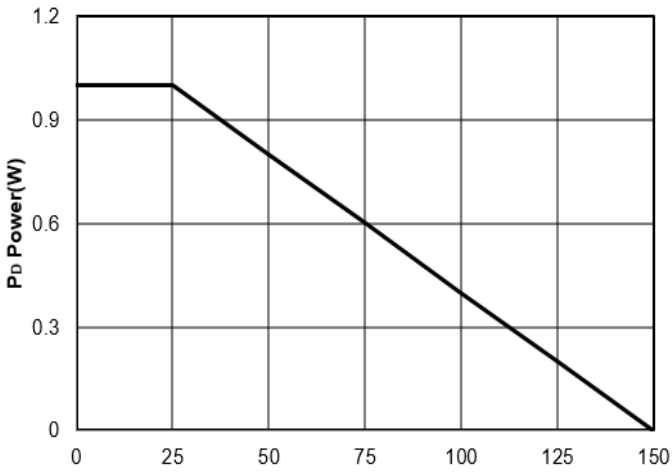


Figure1: T_j Junction Temperature (°C)

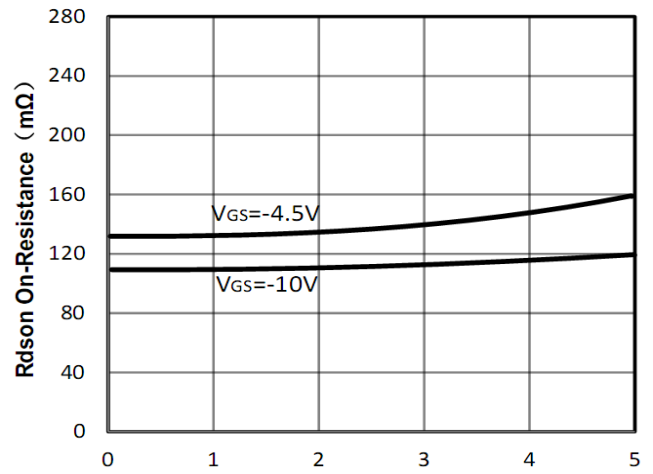


Figure2: I_d Drain Current (A)

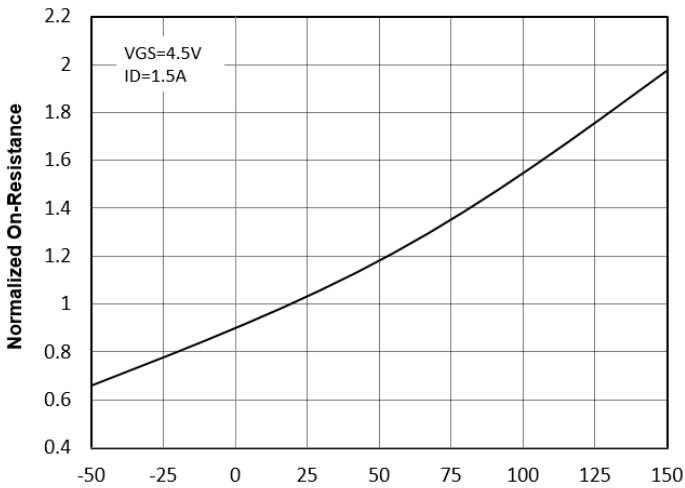


Figure3: T_j Junction Temperature (°C)

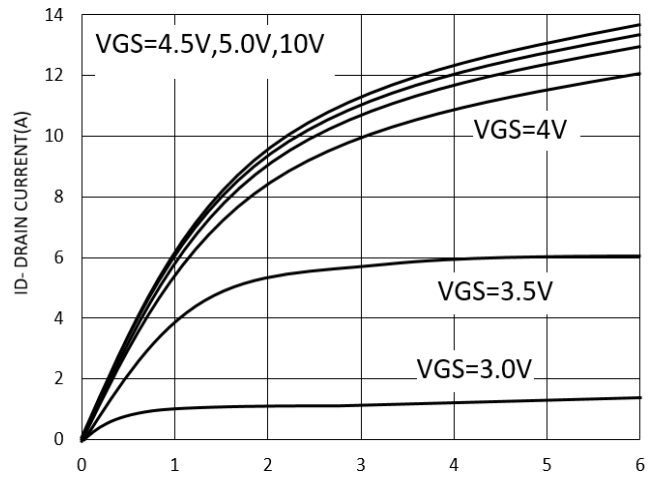


Figure4: V_{ds} Drain-Source Voltage (V)

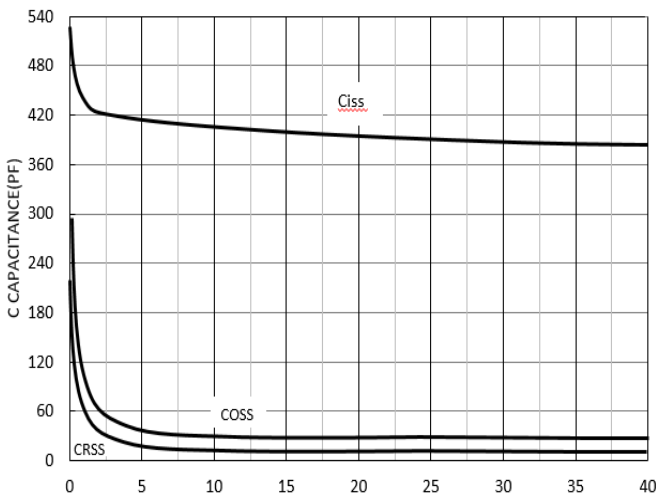


Figure5: V_{ds} Drain-Source Voltage (V)

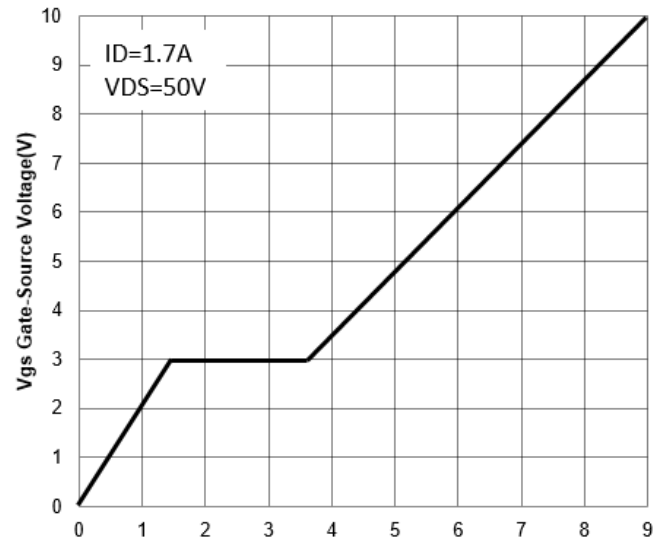


Figure6: Q_g Gate Charge (nC)



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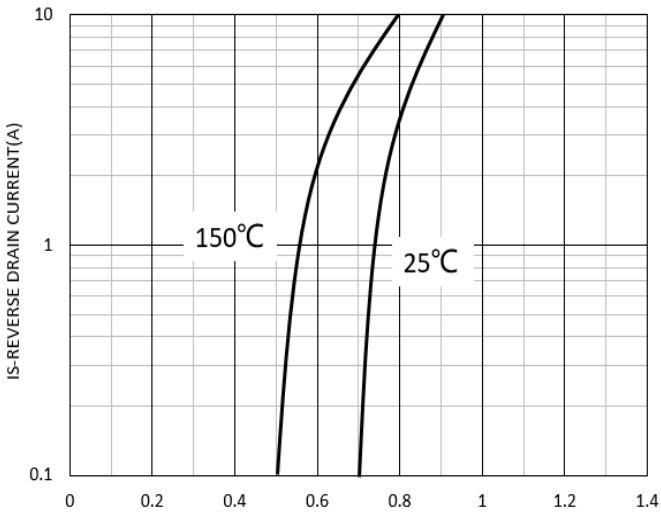


Figure7: Vsd Source-Drain Voltage (V)

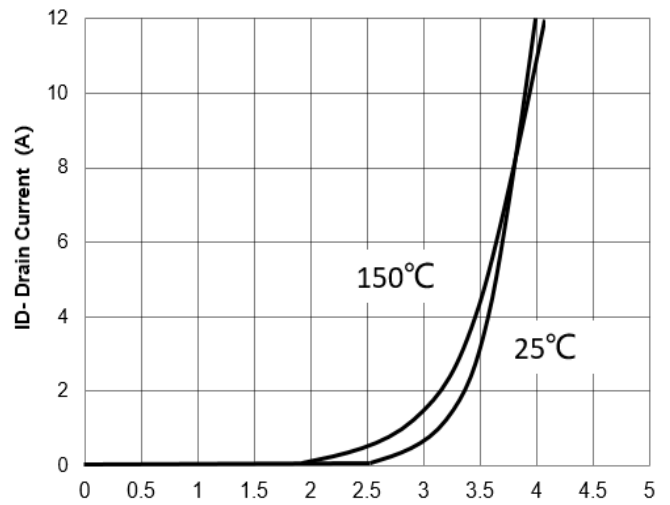


Figure8: Vgs Gate-Source Voltage (V)

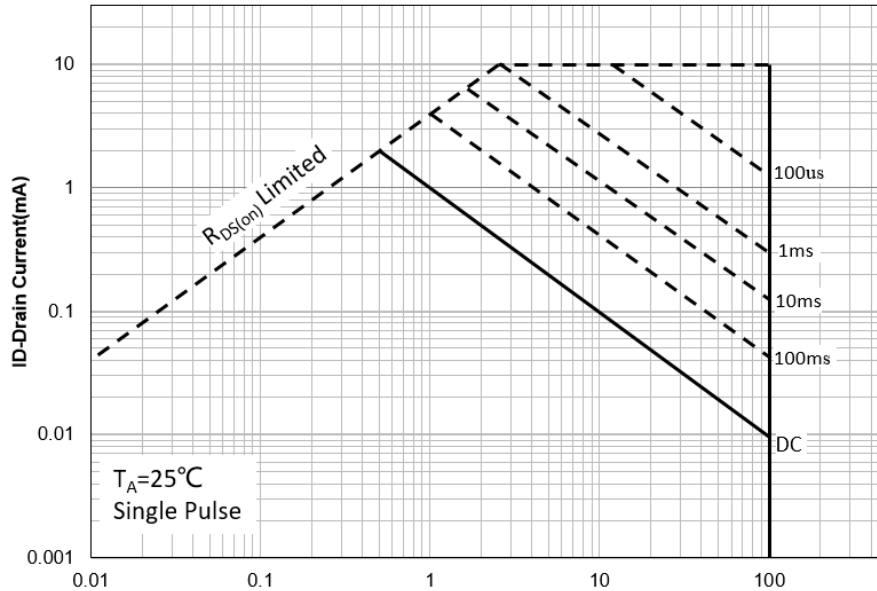


Figure9: Vsd Drain-Source Voltage (V)

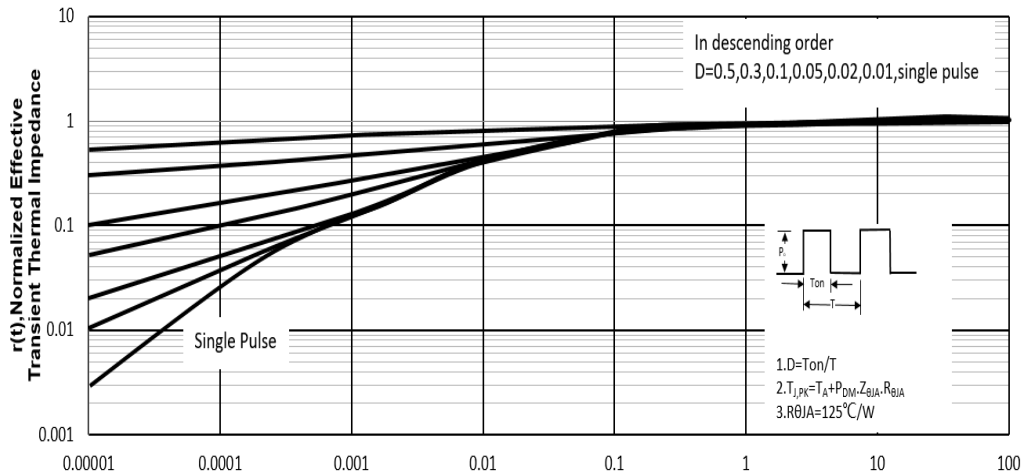
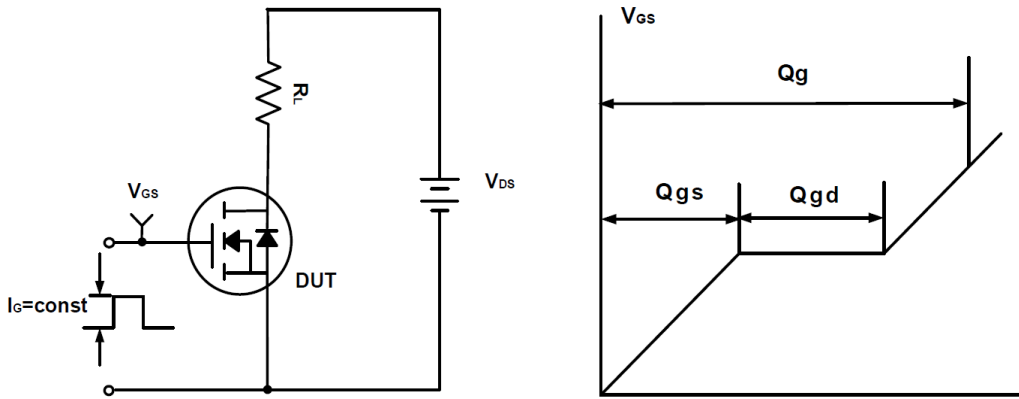
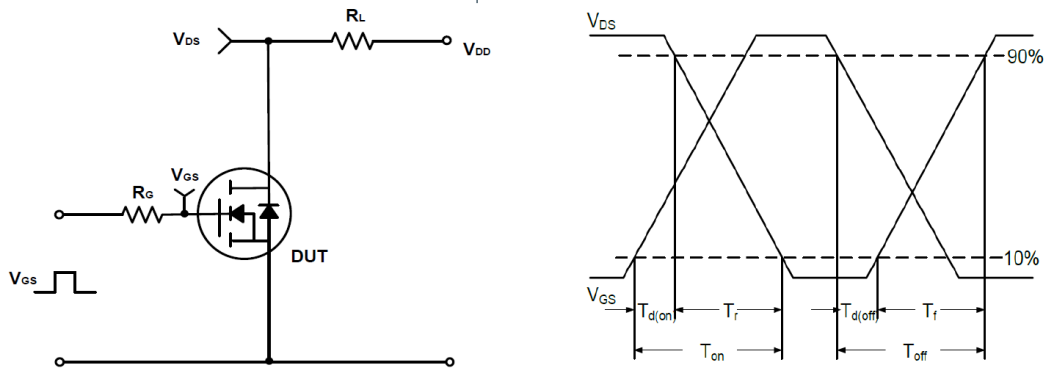
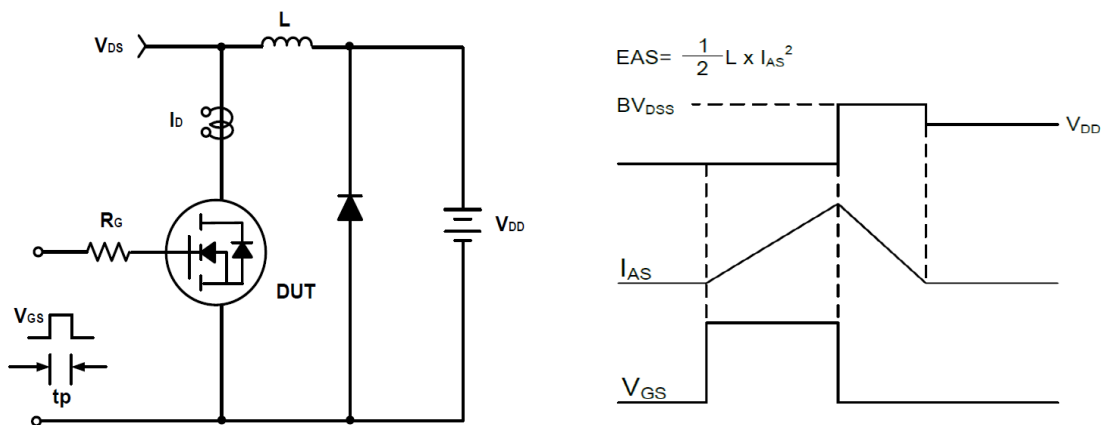


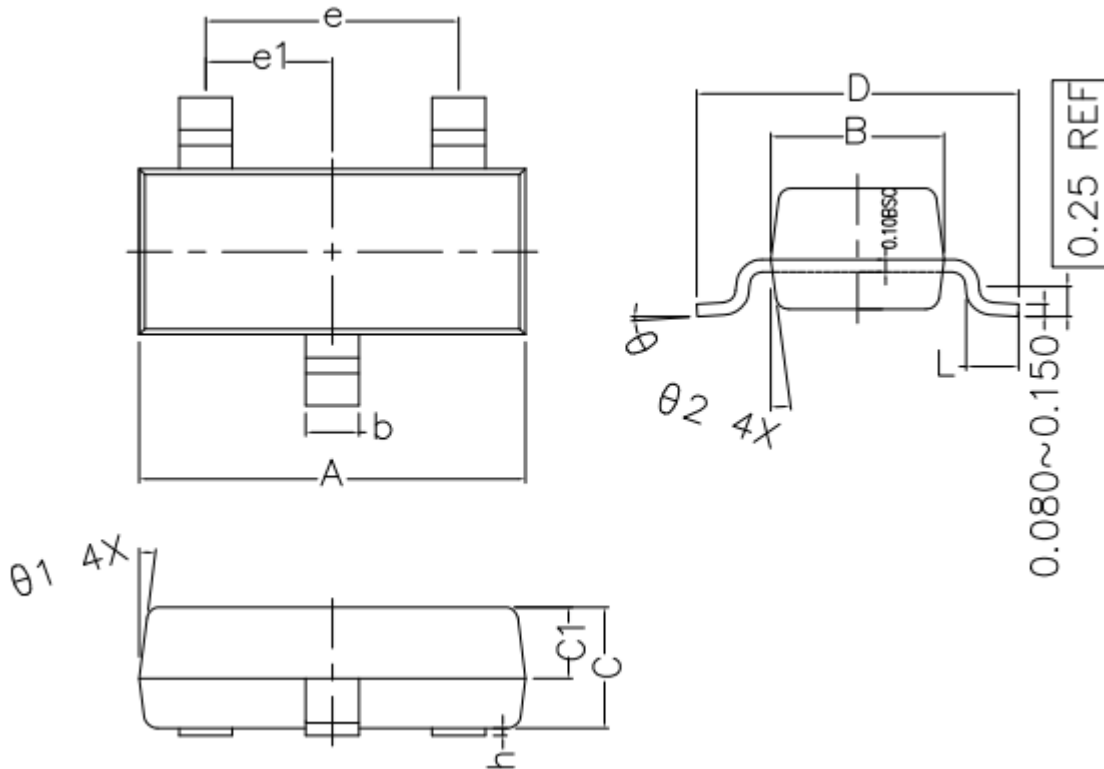
Figure10: Square Wave Pulse Duration (sec)

Test Circuit and Waveform:

Figure A Gate Charge Test Circuit & Waveforms

Figure B Switching Test Circuit & Waveforms

Figure C Unclamped Inductive Switching Circuit & Waveforms



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SOT-23 Package Outline Dimensions (Units: mm)



COMMON DIMENSIONS (UNITS OF MEASURE IS mm)			
	MIN	NORMAL	MAX
A	2.800	2.900	3.000
B	1.200	1.300	1.400
C	0.900	1.000	1.100
C1	0.500	0.550	0.600
D	2.250	2.400	2.550
L	0.300	0.400	0.500
h	0.010	0.050	0.100
b	0.300	0.400	0.500
e	1.90 TYPE		
e1	0.95 TYPE		
theta1	7° TYPE		
theta2	7° TYPE		
theta	0° ~ 7°		